

PRELIMINARY DATA SHEET

SKY77325: iPAC™ PAM for Quad-Band GSM / GPRS

Applications

- Quad-band cellular handsets encompassing
 - Class 4 GSM850/900
 - Class 1 DCS1800 PCS1900
 - Class 12 GPRS multi-slot operation

Features

- Low input power range
 - 0 to 6 dBm
- High efficiency
 - GSM850 49%
 - GSM900 53%
 - DCS 53%
 - PCS 53%
- BiCMOS PA controller and interface IC
 - Low power control slope
 - Fast response time
 - Improved control accuracy
- Integrated closed loop power amplifier control
- Internal Icc sense resistor for PAC
- Input/Output matching 50 internal (with DC blocking)
- 22-pin package
- Small outline
 - 6 mm x 8 mm
- Low profile
 - 1.2 mm maximum
- Gold plated, lead-free contacts

Description

The SKY77325 Power Amplifier Module (PAM) is designed in a low profile (1.2 mm), compact form factor for quad-band cellular handsets comprising GSM850/900, DCS1800, and PCS1900 operation. The PAM also supports Class 12 General Packet Radio Service (GPRS) multi-slot operation.

The module consists of separate GSM850/900 PA and DCS1800/PCS1900 PA blocks, impedance-matching circuitry for 50 Ω input and output impedances, and a Power Amplifier Control (PAC) block with an internal current-sense resistor. The custom BiCMOS integrated circuit provides the internal PAC function and interface circuitry. Fabricated onto a single Gallium Arsenide (GaAs) die, one Heterojunction Bipolar Transistor (HBT) PA block supports the GSM850/900 bands and the other supports the DCS1800 and PCS1900 bands. Both PA blocks share common power supply pins to distribute current. The GaAs die, the Silicon (Si) die, and the passive components are mounted on a multi-layer laminate substrate. The assembly is encapsulated with plastic overmold.

RF input and output ports of the SKY77325 are internally matched to a 50 Ω load to reduce the number of external components for a quad-band design. Extremely low leakage current (2.5 μA, typical) of the dual PA module maximizes handset standby time. The SKY77325 also contains band-select switching circuitry to select GSM (logic 0) or DCS/PCS (logic 1) as determined from the Band Select (BS) signal. In Figure 1 below, the BS pin selects the PA output (DCS/PCS OUT or GSM850/900 OUT) and the Analog Power Control (VAPC) controls the level of output power.

VBATT and VSENSE pins connect to an internal current-sense resistor and interface to an integrated power amplifier control (iPAC™) function, which is insensitive to variations in temperature, power supply, process, and input power. The ENABLE input allows initial turn-on of PAM circuitry to minimize battery drain.

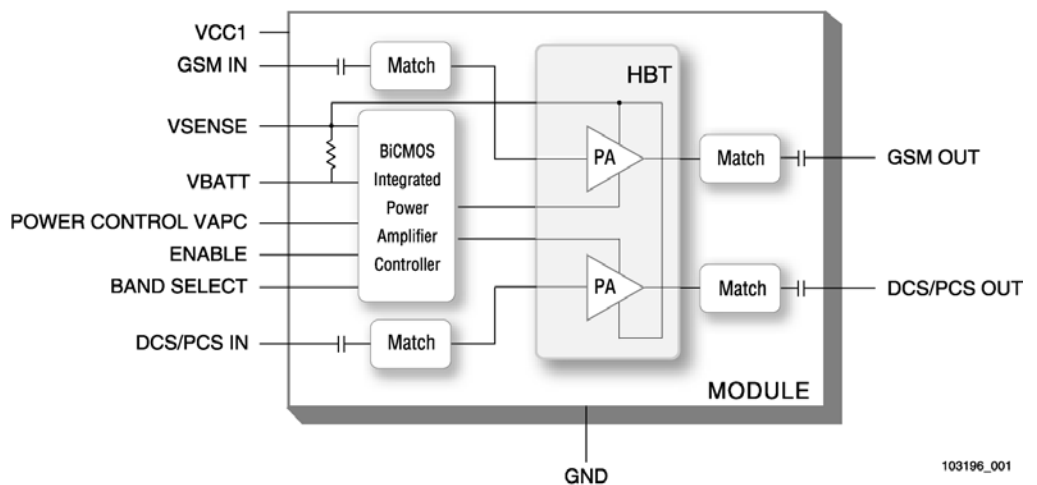


Figure 1. Functional Block Diagram

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Electrical Specifications

The following tables list the electrical characteristics of the SKY77325 Power Amplifier Module. [Table 1](#) lists the absolute maximum ratings and [Table 2](#) shows the recommended operating conditions. lists the electrical characteristics of the SKY77325 for modes GSM850, GSM900, DCS1800, and PCS1900. [Figure 2](#) is a

diagram of a typical SKY77325 application.

The SKY77325 is a static-sensitive electronic device and should not be stored or operated near strong electrostatic fields. Detailed information on device dimensions, pin descriptions, packaging and handling can be found in later sections of this data sheet.

Table 1. Absolute Maximum Ratings

Parameter	Minimum	Maximum	Unit
Input Power (P _{IN})	—	15	dBm
Supply Voltage (V _{CC}), Standby, V _{APC} ≤ 0.3 V, ENABLE ≤ 0.2 V	—	7	V
Control Voltage (V _{APC})	-0.5	V _{CC,MAX} - 0.2 (See Table 3)	V
Storage Temperature	-55	+100	°C

Table 2. Recommended Operating Conditions

Parameter	Minimum	Typical	Maximum	Unit
Supply Voltage (V _{CC})	2.9	3.5	4.8V	V
Supply Current (I _{CC})	0	—	2.5	A
Operating Case Temperature (T _{CASE}) – Package Bottom Surface				
1-Slot (12.5% duty cycle)	-20	—	+100	°C
2-Slot (25.0% duty cycle)	-20	—	+100	
3-Slot (37.5% duty cycle)	-20	—	+85	
4-Slot (50.0% duty cycle)	-20	—	+85	

[查询"SKY77325"供应商](#)**Table 3. SKY77325 Electrical Specifications⁽¹⁾ (1 of 8)**

Parameter	Symbol	Test Condition	Minimum	Typical	Maximum	Units
General						
Supply voltage	V _{CC}	—	2.9	3.5	4.8	V
Power control impedance	Z _{APC}	—	—	200	—	kΩ
ENABLE control voltage	Low	V _{PE}	—	—	0.6	V
	High	V _{PE}	—	—	V _{CC}	
ENABLE current	I _{PE}	V _{PE} ≤ 3.0 V	—	—	30	μA
Band Select control voltage	Low	V _{BS}	—	—	0.6	V
	High	V _{BS}	—	—	V _{CC}	
Band Select current	I _{BS}	V _{BS} ≤ 3.0 V	—	—	30	μA
Standby Mode Leakage current	I _Q	V _{CC} ≤ 4.5 V V _{APC} = 0.1 V ENABLE ≤ 0.2 V T _{CASE} = +25 °C P _{IN} ≤ -60 dBm	—	2.5	10	μA
V _{APC} Input Filter Bandwidth	V _{APC} FBW	—	85	120	150	kHz
V _{APC} Threshold	V _{APC} THCL	—	150	200	250	mV
GSM850 Mode (f = 824 to 849 MHz and P_{IN} = 0 to 6dBm)						
Frequency range	f		824	—	849	MHz
Input power	P _{IN}		0	—	6	dBm
Analog power control voltage	V _{APC}		0.2	—	2.1	V
Power Added Efficiency	PAE	V _{CC} = 3.5 V P _{OUT} = 34.5 dBm ENABLE > 2.0 V pulse width 577 μs duty cycle 1:8 T _{CASE} = +25 °C	45	49	—	%
2nd to 13th harmonics	2f ₀ to 13f ₀	BW = 3 MHz 6.5 dBm ≤ P _{OUT} ≤ 34.5 dBm	—	-25	-10	dBm
Output power	P _{OUT}	V _{CC} = 3.5 V T _{CASE} = +25 °C	34.5	35.0	—	dBm
	P _{OUT} MAX LOW VOLTAGE	V _{CC} = 2.9 V ENABLE > 2.0 V T _{CASE} = -20 °C to +100 °C (See Table 2 for multislot.) P _{IN} = 0 dBm	32.0	34.0	—	
	P _{OUT} MAX HIGH VOLTAGE	V _{CC} = 4.5 V ENABLE > 2.0 V T _{CASE} = -20 °C to +100 °C (See Table 2 for multislot.) P _{IN} = 0 dBm	32.0	35.7	—	
Input VSWR	Γ _{IN}	P _{OUT} = 6.5 to 34.5 dBm, controlled by V _{APC}	—	1.5:1	2.0:1	—
Forward isolation	P _{OUT} STANDBY	P _{IN} = 6 dBm V _{APC} = 0.1 V ENABLE ≤ 0.2 V	—	-40	-35	dBm

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Table 3. SKY77325 Electrical Specifications⁽¹⁾ (2 of 8)

Parameter	Symbol	Test Condition	Minimum	Typical	Maximum	Units
Spurious	Spur	All combinations of the following parameters: V _{APC} = controlled ⁽²⁾ P _{IN} = min. to max. V _{CC} = 2.9 V to 4.8 V Load VSWR = 8:1, all phase angles	No parasitic oscillation > -36 dBm			
Load mismatch	Load	All combinations of the following parameters: V _{APC} = controlled ⁽²⁾ P _{IN} = min. to max. V _{CC} = 2.9 V to 4.8 V Load VSWR = 10:1, all phase angles	No module damage or permanent degradation			
Noise power	P _{NOISE}	At f ₀ + 20 MHz RBW = 100 kHz V _{CC} = 3.5 V 6.5 dBm ≤ P _{OUT} ≤ 34.5 dBm T _{CASE} = +25 °C	—	-84	-82	dBm
		At f ₀ + 10 MHz RBW = 100 kHz V _{CC} = 3.5 V 6.5 dBm ≤ P _{OUT} ≤ 34.5 dBm T _{CASE} = +25 °C	—	-81	-76	dBm
		At 1805 to 1880 MHz RBW = 100 kHz V _{CC} = 3.5 V 6.5 dBm ≤ P _{OUT} ≤ 34.5 dBm T _{CASE} = +25 °C	—	-106	-84	dBm
Coupling of Fundamental, 2nd, and 3rd harmonics from the GSM band into the DCS/PCS band	f ₀	Measured at the DCS/PCS output -15 dBm ≤ P _{OUT} ≤ 34.5 dBm	—	-8	0	dBm
	2f ₀		—	-30	-20	
	3f ₀		—	-30	-20	
Power control dynamic range	P _{CDR}	—	30	50		dB
Power control variation ⁽⁴⁾ (Control level 5–15) 3.2 ≤ V _{CC} ≤ 4.5	P _{CV}	P _{OUT} +14.5 to +34.5 dBm, +25 °C	-0.8	—	+0.8	dB
		P _{OUT} +14.5 to +34.5 dBm	-1.2	—	+1.2	
Power control variation ⁽⁴⁾ (Control level 16–19)	P _{CV}	P _{OUT} +6.5 to +12.5 dBm, +25 °C	-0.9	—	+0.9	dB
		P _{OUT} +6.5 to +12.5 dBm	-1.3	—	+1.3	
Power control slope	P _{CS}	6.5 to 34.5 dBm	—	—	150	dB/V

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Parameter	Symbol	Test Condition	Minimum	Typical	Maximum	Units
GSM900 Mode (f = 880 to 915 MHz and P_{IN} = 0 to 6 dBm)						
Frequency range	f	—	880	—	915	MHz
Input power	P _{IN}	—	0	—	6	dBm
Analog power control voltage	V _{APC}	—	0.2	—	2.1	V
Power Added Efficiency	PAE	V _{CC} = 3.5 V P _{OUT} = 34.5 dBm ENABLE > 2.0 V pulse width 577 μs duty cycle 1:8 T _{CASE} = +25 °C	49	53	—	%
2nd to 13th harmonics	2f ₀ to 13f ₀	BW = 3 MHz 6.5 dBm ≤ P _{OUT} ≤ 34.5 dBm	—	-30	-10	dBm
Output power	P _{OUT}	V _{CC} = 3.5 V T _{CASE} = +25 °C	34.5	35.0	—	dBm
	P _{OUT} MAX LOW VOLTAGE	V _{CC} = 2.9 V ENABLE > 2.0 V T _{CASE} = -20 °C to +100 °C (See Table 2 for multislot.) P _{IN} = 0 dBm	32.0	33.0	—	
	P _{OUT} MAX HIGH VOLTAGE	V _{CC} = 4.5 V ENABLE > 2.0 V T _{CASE} = -20 °C to +100 °C (See Table 2 for multislot.) P _{IN} = 0 dBm	32.0	36.3	—	
Input VSWR	Γ _{IN}	P _{OUT} = 6.5 to 34.5 dBm, controlled by V _{APC}	—	1.5:1	2.0:1	—
Forward isolation	P _{OUT} STANDBY	P _{IN} = 6 dBm V _{APC} = 0.1 V ENABLE ≤ 0.2 V	—	-40	-35	dBm

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Table 3. SKY77325 Electrical Specifications⁽¹⁾ (4 of 8)

Parameter	Symbol	Test Condition	Minimum	Typical	Maximum	Units
Spurious	Spur	All combinations of the following parameters: V _{APC} = controlled ⁽²⁾ P _{IN} = min. to max. V _{CC} = 2.9 V to 4.8 V Load VSWR = 8:1, all phase angles	No parasitic oscillation > -36 dBm			
Load mismatch	Load	All combinations of the following parameters: V _{APC} = controlled ⁽²⁾ P _{IN} = min. to max. V _{CC} = 2.9 V to 4.8 V Load VSWR = 10:1, all phase angles	No module damage or permanent degradation			
Noise power	P _{NOISE}	At f ₀ + 20 MHz RBW = 100 kHz V _{CC} = 3.5 V 6.5 dBm ≤ P _{OUT} ≤ 34.5 dBm T _{CASE} = +25 °C	—	-84	-82	dBm
		At f ₀ + 10 MHz RBW = 100 kHz V _{CC} = 3.5 V 6.5 dBm ≤ P _{OUT} ≤ 34.5 dBm T _{CASE} = +25 °C	—	-81	-76	
		At 1805 to 1880 MHz RBW = 100 kHz V _{CC} = 3.5 V 6.5 dBm ≤ P _{OUT} ≤ 34.5 dBm T _{CASE} = +25 °C	—	-106	-84	
Coupling of Fundamental, 2nd, and 3rd harmonics from the GSM band into the DCS/PCS band	f ₀	Measured at the DCS/PCS output, -15 dBm ≤ P _{OUT} ≤ 34.5 dBm	—	-12	0	dBm
	2f ₀		—	-30	-20	
	3f ₀		—	-30	-20	
Power control dynamic range	P _{CDR}	—	30	50	—	dB
Power control variation ⁽⁴⁾ (Control level 5–15) 3.2 ≤ V _{CC} ≤ 4.5	P _{CV}	P _{OUT} +14.5 to +34.5 dBm, +25 °C	-0.8	—	+0.8	dB
		P _{OUT} +14.5 to +34.5 dBm	-1.2	—	+1.2	
Power control variation ⁽⁴⁾ (Control level 16–19)	P _{CV}	P _{OUT} +6.5 to +12.5 dBm, +25 °C	-0.9	—	+0.9	dB
		P _{OUT} +6.5 to +12.5 dBm	-1.3	—	+1.3	
Power control slope	P _{CS}	6.5 to 34.5 dBm	—	—	150	dB/V

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Parameter	Symbol	Test Condition	Minimum	Typical	Maximum	Units
DCS1800 Mode (f = 1710 to 1785 MHz and P_{IN} = 0 to 6 dBm)						
Frequency range	f	—	1710	—	1785	MHz
Input power	P _{IN}	—	0	—	6	dBm
Analog power control voltage	V _{APC}	—	0.2	—	2.1	V
Power Added Efficiency	PAE	V _{CC} = 3.5 V P _{OUT} = 32.0 dBm ENABLE > 2.0 V pulse width 577 μs duty cycle 1:8 T _{CASE} = +25 °C	45	53	—	%
	PAE _{LOW INPUT}	V _{CC} = 3.5 V P _{OUT} = 32.0 dBm ENABLE > 2.0 V pulse width 577 μs duty cycle 1:8 T _{CASE} = +25 °C P _{IN} = -2 dBm	—	51	—	
2nd to 7th harmonics	2f ₀ to 7f ₀	BW = 3 MHz 1.5 dBm ≤ P _{OUT} ≤ 32.0 dBm	—	-22	-10	dBm
Output power	P _{OUT}	V _{CC} = 3.5 V T _{CASE} = +25 °C	32.0	33.0	—	dBm
	P _{OUT MAX LOW INPUT}	V _{CC} = 3.5 V T _{CASE} = +25 °C P _{IN} = -2 dBm	—	32.1	—	
	P _{OUT MAX LOW VOLTAGE}	V _{CC} = 2.9 V ENABLE > 2.0 V T _{CASE} = -20 °C to +100 °C (See Table 2 for multislot.) P _{IN} = 0 dBm	29.0	31.0	—	
	P _{OUT MAX HIGH VOLTAGE}	V _{CC} = 4.5 V ENABLE > 2.0 V T _{CASE} = -20 °C to +100 °C (See Table 2 for multislot.) P _{IN} = 0 dBm	29.0	34.3	—	
Input VSWR	Γ _{IN}	P _{OUT} = 1.5 to 32.0 dBm, controlled by V _{APC}	—	1.5:1	2.0:1	—

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Table 3. SKY77325 Electrical Specifications⁽¹⁾ (6 of 8)

Parameter	Symbol	Test Condition	Minimum	Typical	Maximum	Units
Forward isolation	P _{OUT STANDBY}	P _{IN} = 6 dBm V _{APC} = 0.1 V ENABLE ≤ 0.2 V	—	-40	-35	dBm
Spurious	Spur	All combinations of the following parameters: V _{APC} = controlled ⁽³⁾ P _{IN} = min. to max. V _{CC} = 2.9 V to 4.8 V Load VSWR = 8:1, all phase angles	No parasitic oscillation > -36 dBm			
Load mismatch	Load	All combinations of the following parameters: V _{APC} = controlled ⁽³⁾ P _{IN} = min. to max. V _{CC} = 2.9 V to 4.8 V Load VSWR = 10:1, all phase angles	No module damage or permanent degradation			
Noise power	P _{NOISE}	At f ₀ + 20 MHz RBW = 100 kHz V _{CC} = 3.5 V 1.5 dBm ≤ P _{OUT} ≤ 32.0 dBm T _{CASE} = +25 °C	—	-82	-80	dBm
		At 925 to 960 MHz RBW = 100 kHz V _{CC} = 3.5 V 1.5 dBm ≤ P _{OUT} ≤ 32.0 dBm T _{CASE} = +25 °C	—	-97	-87	
Power control dynamic range	P _{CDR}	—	35	50	—	dB
Power control variation ⁽⁴⁾ (Control level 0–8) 3.2 V ≤ V _{CC} ≤ 4.5 V	P _{CV}	P _{OUT} +15.5 to +32.0 dBm, +25 °C	-1.0	—	+1.0	dB
		P _{OUT} +15.5 to +32.0 dBm	-1.4	—	+1.4	
Power control variation ⁽⁴⁾ (Control level 9–13)	P _{CV}	P _{OUT} +5.5 to +13.5 dBm, +25 °C	-1.3	—	+1.3	dB
		P _{OUT} +5.5 to +13.5 dBm	-1.6	—	+1.6	
Power control variation ⁽⁴⁾ (Control level 14–15)	P _{CV}	P _{OUT} +1.5 to +3.5 dBm, +25 °C	-1.7	—	+1.7	dB
		P _{OUT} +1.5 to +3.5 dBm	-2.2	—	+2.2	
Power control slope	P _{CS}	1.5 to 32.0 dBm	—	—	150	dB/V

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Parameter	Symbol	Test Condition	Minimum	Typical	Maximum	Units
PCS1900 Mode (f = 1850 to 1910 MHz and P_{IN} = 0 to 6 dBm)						
Frequency range	F	—	1850		1910	MHz
Input power	P _{IN}	—	0		6	dBm
Analog power control voltage	V _{APC}	—	0.2		2.1	V
Power Added Efficiency	PAE	V _{CC} = 3.5 V P _{OUT} = 32.0 dBm ENABLE > 2.0 V pulse width 577 μs duty cycle 1:8 T _{CASE} = +25 °C	45	53	—	%
	PAE _{LOW INPUT}	V _{CC} = 3.5 V P _{OUT} = 32.0 dBm ENABLE > 2.0 V pulse width 577 μs duty cycle 1:8 T _{CASE} = +25 °C P _{IN} = -2 dBm	—	51	—	
2nd to 7th harmonics	2f ₀ to 7f ₀	BW = 3 MHz 1.5 dBm ≤ P _{OUT} ≤ 32.0 dBm	—	-18	-10	dBm
Output power	P _{OUT}	V _{CC} = 3.5 V T _{CASE} = +25 °C	32.0	33.0	—	dBm
	P _{OUT MAX LOW INPUT}	V _{CC} = 3.5 V T _{CASE} = +25 °C P _{IN} = -2 dBm	—	32.5	—	
	P _{OUT MAX LOW VOLTAGE}	V _{CC} = 2.9 V ENABLE > 2.0 V T _{CASE} = -20 °C to +100 °C (See Table 2 for multislot.) P _{IN} = 0 dBm	29.0	31.0	—	
	P _{OUT MAX HIGH VOLTAGE}	V _{CC} = 4.5 V ENABLE > 2.0 V T _{CASE} = -20 °C to +100 °C (See Table 2 for multislot.) P _{IN} = 0 dBm	29.0	34.1	—	
Input VSWR	Γ _{IN}	P _{OUT} = 1.5 to 32.0 dBm, controlled by V _{APC}	—	1.5:1	2.0:1	—
Forward isolation	P _{OUT STANDBY}	P _{IN} = 6 dBm V _{APC} = 0.1 V ENABLE ≤ 0.2 V	—	-40	-35	dBm

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Table 3. SKY77325 Electrical Specifications ⁽¹⁾ (8 of 8)

Parameter	Symbol	Test Condition	Minimum	Typical	Maximum	Units
Spurious	Spur	All combinations of the following parameters: V _{APC} = controlled ⁽³⁾ P _{IN} = min. to max. V _{CC} = 2.9 V to 4.8 V Load VSWR = 8:1, phase angles	No parasitic oscillation > -36 dBm			
Load mismatch	Load	All combinations of the following parameters: V _{APC} = controlled ⁽³⁾ P _{IN} = min. to max. V _{CC} = 2.9 V to 4.8 V Load VSWR = 10:1, all phase angles	No module damage or permanent degradation			
Noise power	P _{NOISE}	At f ₀ + 20 MHz RBW = 100 kHz V _{CC} = 3.5 V 1.5 dBm ≤ P _{OUT} ≤ 32.0 dBm T _{CASE} = +25 °C	—	-82	-80	dBm
		At 869 to 894 MHz RBW = 100 kHz V _{CC} = 3.5 V 1.5 dBm ≤ P _{OUT} ≤ 32.0 dBm T _{CASE} = +25 °C	—	-97	-87	
Power control dynamic range	P _{CDR}	—	35	50	—	dB
Power control variation ⁽⁴⁾ (Control level 0–8) 3.2 V ≤ V _{CC} ≤ 4.5 V	P _{CV}	P _{OUT} +15.5 to +32.0 dBm, +25 °C	-1.0	—	+1.0	dB
		P _{OUT} +15.5 to +32.0 dBm	-1.4	—	+1.4	
Power control variation ⁽⁴⁾ (Control level 9–13)	P _{CV}	P _{OUT} +5.5 to +13.5 dBm, +25 °C	-1.3	—	+1.3	dB
		P _{OUT} +5.5 to +13.5 dBm	-1.6	—	+1.6	
Power control variation ⁽⁴⁾ (Control level 14–15)	P _{CV}	P _{OUT} +1.5 to +3.5 dBm, +25 °C	-1.7	—	+1.7	dB
		P _{OUT} +1.5 to +3.5 dBm	-2.2	—	+2.2	
Power control slope	P _{CS}	1.5 to 32.0 dBm	—	—	150	dB/V

⁽¹⁾ Unless specified otherwise:

T_{CASE} = -20 °C to max. operating temperature (see Table 2)

RL = 50 Ω

pulsed operation with pulse width ≤ 1154 μs and duty cycle ≤ 2:8

V_{CC} = 2.9 V to 4.8 V.

⁽²⁾ I_{CC} = 0A to xA, where x = current at P_{OUT} = 34.5 dBm, 50 Ω load, and V_{CC} = 3.5 V.

⁽³⁾ I_{CC} = 0A to xA, where x = current at P_{OUT} = 32.0 dBm, 50 Ω load, and V_{CC} = 3.5 V.

⁽⁴⁾ Power control variation is measured by comparing power obtained at a specified control voltage over all conditions, against the power obtained with the same control voltage at nominal conditions. For this module, nominal conditions are defined as:

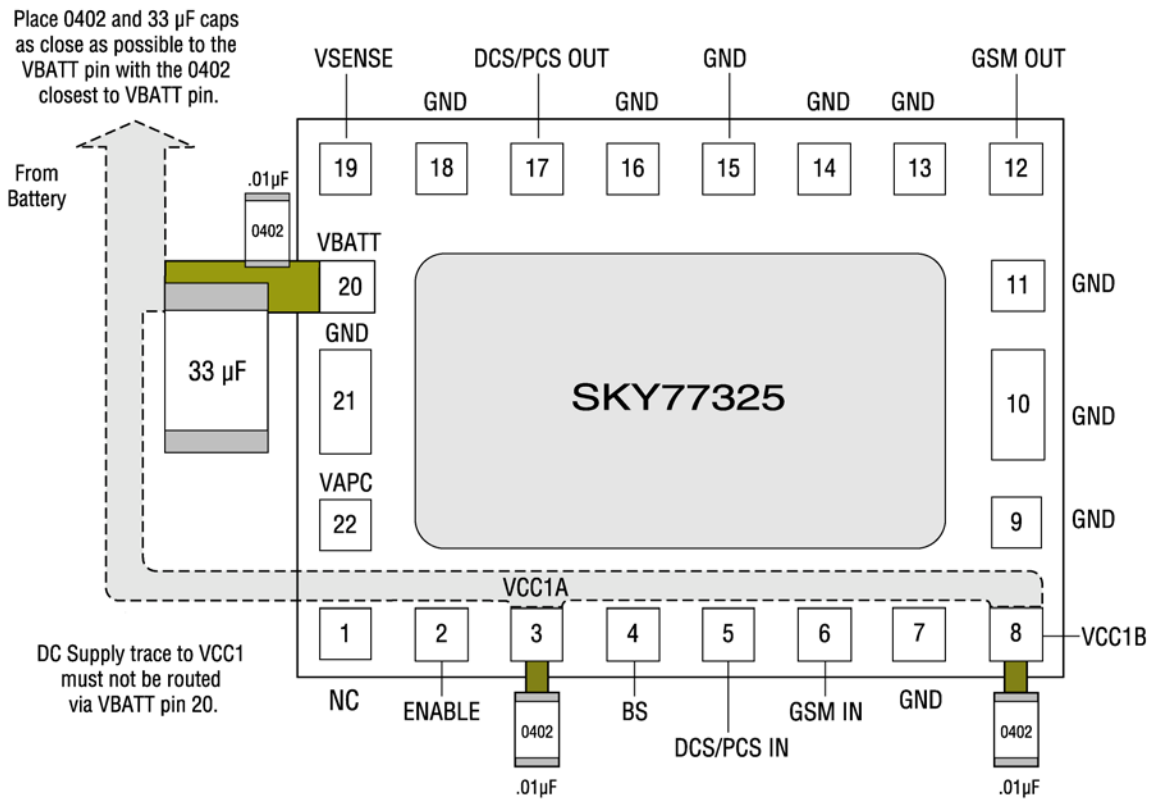
T = 25 °C

V_{CC} = 3.5 V

P_{IN} = 3 dBm

Frequency = mid-band

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NOTES:

1. The value of 33 µF cap depends on the noise level on the phone board.
2. Depending on phone board noise level, not all 0402 and 0.01 µF caps may be needed.
3. Ensure sufficient numbers of vias connect VBATT pin to battery trace.
4. VBATT trace should be ≥ 1.0 mm.
5. Ensure sufficient numbers of vias connect VCC1A and B to battery trace.
6. VCC1A and B trace widths should be ≥ 0.25 mm.
7. Ground terminals of all bypass caps are connected to ground plane with vias.
8. Dotted traces can be routed in the inner layers.

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Figure 2. Typical SKY77325 PAM Application

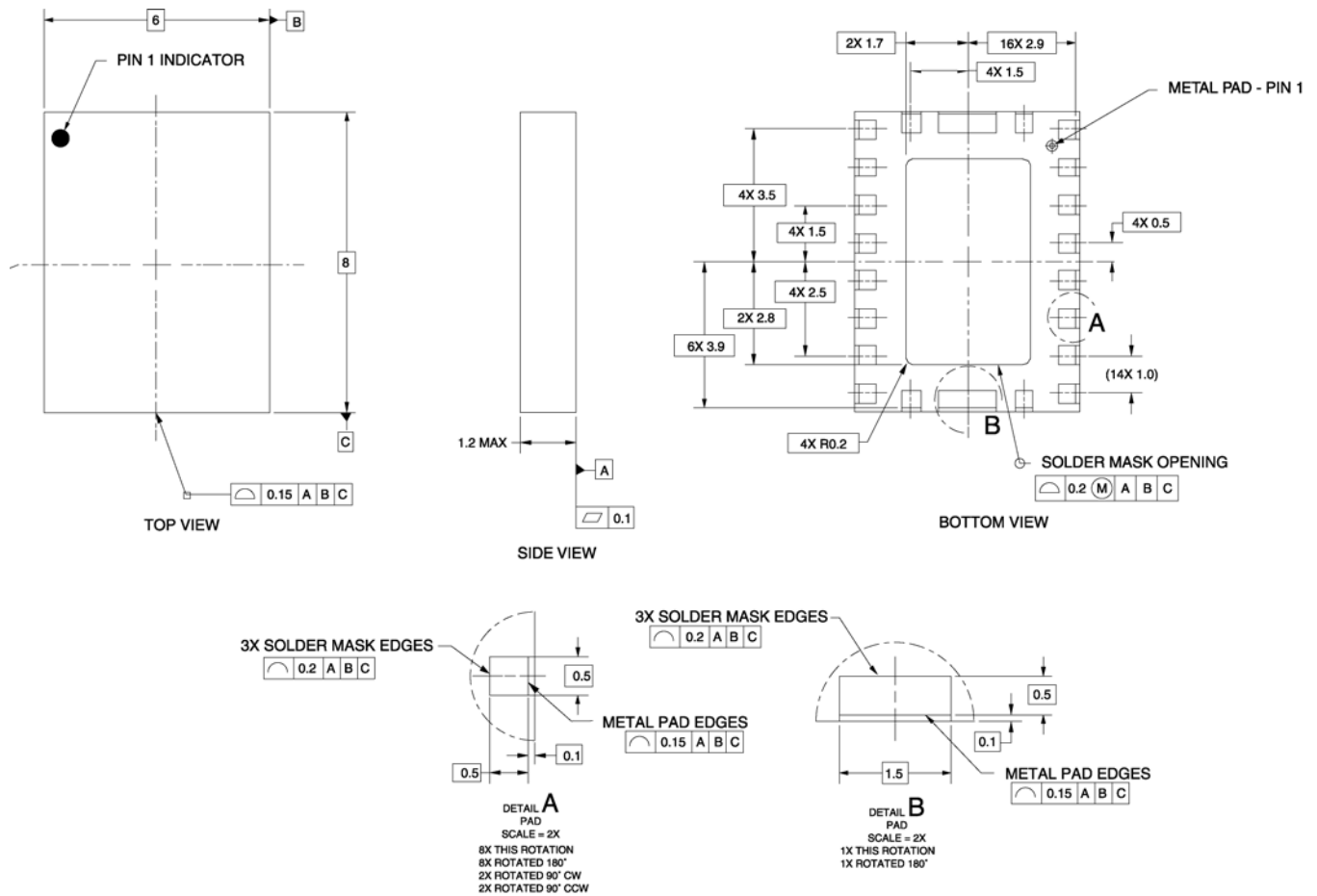
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Package Dimensions and Pin Description

Figure 3 is a mechanical diagram of the pad layout for the SKY77325, a 22-pin leadless quad-band PA module. Figure 4 provides a recommended phone board layout footprint for the PAM to help the designer attain optimum thermal conductivity, good grounding, and minimum RF discontinuity for the 50 ohm

terminals.

Figure 5 shows the device pin configuration and Table 4 lists the pin names and signal descriptions. The pin numbering convention starts with pin 1 at the upper left, as indicated in Figure 5, and increments counter-clockwise around the package. Figure 6 interprets typical case markings.



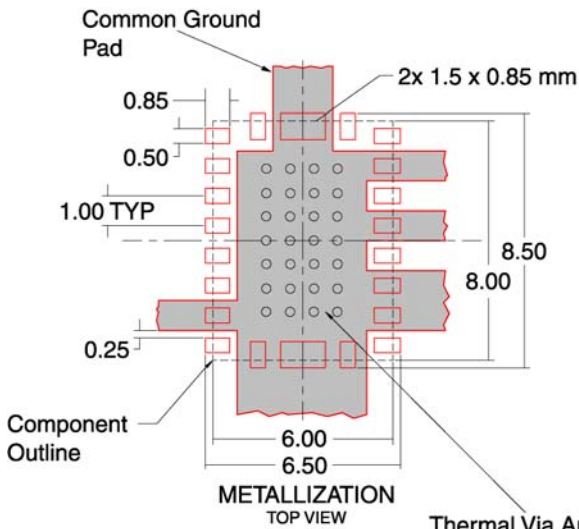
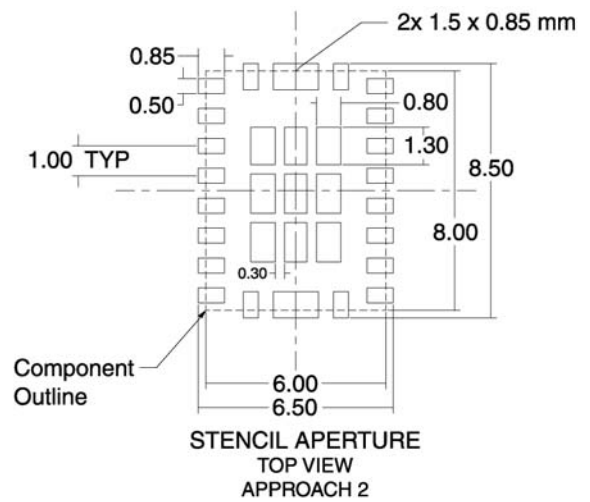
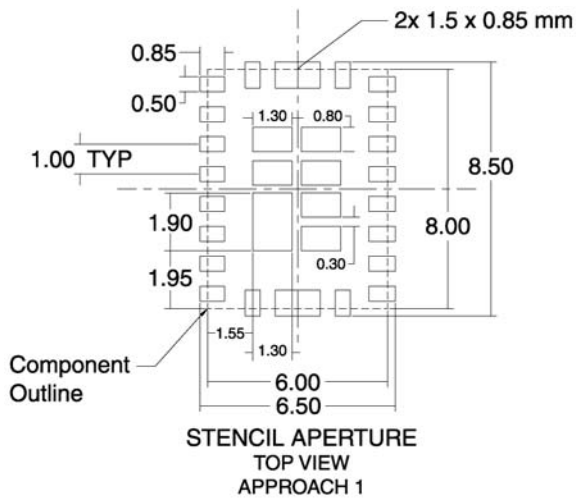
NOTES: unless otherwise specified.

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCES IN ACCORDANCE WITH ASME Y14.5M-1994.
3. PADS ARE METAL DEFINED; CENTER AND EDGE GROUND PAD ARE SOLDER MASK DEFINED

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Figure 3. SKY77325 PAM Package Dimensions—22-Pin Leadless (All Views)

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Thermal Via Array
 $\phi 0.3$ mm on 0.8 mm pitch
 Additional vias will improve thermal performance.
 NOTE: Thermal vias should be tented and filled with solder mask, 30–35 μ m Cu plating recommended.

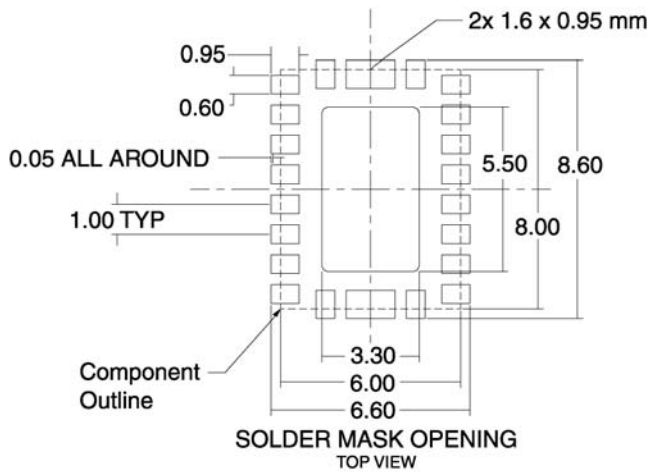


Figure 4. Phone Board Layout Footprint for 6 x 8 mm Package

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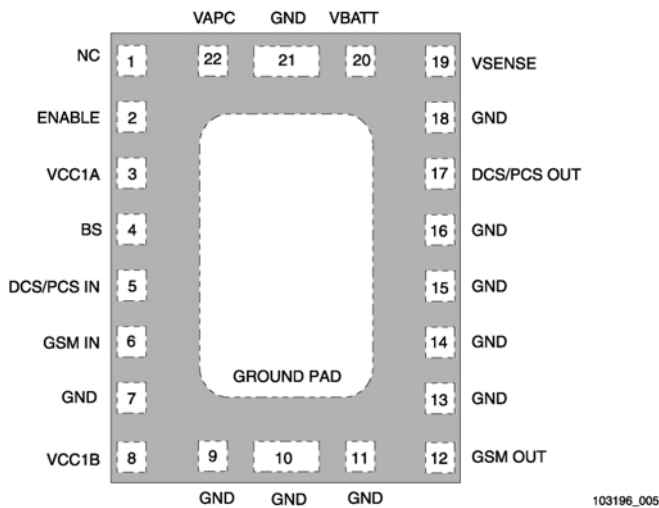


Figure 5. SKY77325 PAM Pin Configuration—22-Pin Leadless (Top View)

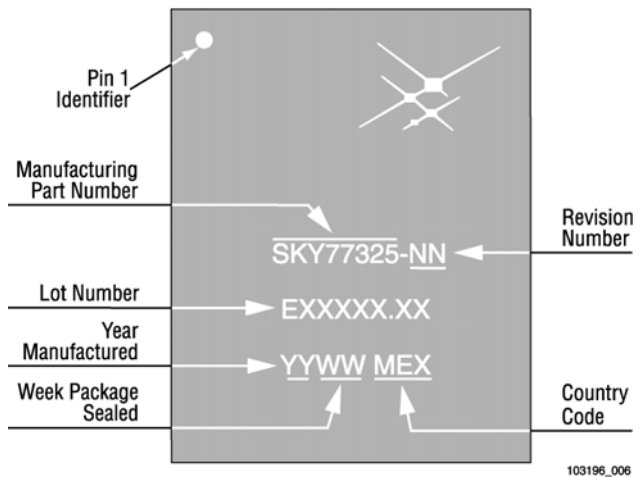


Figure 6. Typical Case Markings

Table 4. SKY77325 Pin Names and Signal Descriptions

Pin	Name	Description
1	NC	NO INTERNAL CONNECTION
2	ENABLE	BiCMOS enable
3	VCC1A	VCC (to GSM 1st stage, DCS 1st stages)
4	BS	Band Select
5	DCS/PCS IN	RF input 1710–1910 MHz
6	GSM850/900 IN	RF input 824–915 MHz
7	GND	RF and DC Ground
8	VCC1B	VCC (to BiCMOS PAC, GSM 2nd stage, DCS 2nd stage)
9	GND	RF and DC Ground
10	GND	RF and DC Ground
11	GND	RF and DC Ground
12	GSM850/900 OUT	RF Output 824–915 MHz
13	GND	RF and DC Ground
14	GND	RF and DC Ground
15	GND	RF and DC Ground
16	GND	RF and DC Ground
17	DCS/PCS OUT	RF Output 1710–1910 MHz
18	GND	RF and DC Ground
19	VSENSE	Voltage output of low side of internal sense resistor (DO NOT CONNECT.)
20	VBATT	Battery input to high side of internal sense resistor
21	GND	RF and DC Ground
22	VAPC	Power Control Bias Voltage
GND PAD (23)	GND	Ground Pad, bottom

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Package and Handling Information

Because of its sensitivity to moisture absorption, this device package is baked and vacuum-packed prior to shipment. Instructions on the shipping container label must be followed regarding exposure to moisture after the container seal is broken, otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY77325 is currently qualified for MSL3/240 °C. Demonstration of the SKY77325 to withstand an MSL3/250 °C solder reflow is pending completion of qualification tests.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. If the part is attached in a reflow oven, the temperature ramp rate should not exceed 5 °C per second; maximum temperature should not exceed 250 °C. If the part is manually attached, precaution should be taken to insure that the part is not subjected to temperatures exceeding 250 °C for more than 10 seconds. For details on attachment techniques, precautions, and handling procedures recommended by Skyworks, please refer to *Application Note: PCB Design and SMT Assembly/Rework, Document Number 101752*. Additional information on standard SMT reflow profiles can also be found in the *JEDEC Standard J-STD-020B*.

Production quantities of this product are shipped in the standard tape-and-reel format. For packaging details, refer to *Application Note: Tape and Reel, Document Number 101568*.

Electrostatic Discharge Sensitivity

The SKY77325 is a Class I device. [Figure 7](#) lists the Electrostatic Discharge (ESD) immunity level for each pin of the SKY77325 module. The numbers specify the ESD threshold levels for each pin where the I-V curve between the pin and ground starts to show degradation.

ESD testing was performed in compliance with MIL-STD-883E Method 3015.7 using the Human Body Model. If the magnitude of ESD damage threshold is found to consistently exceed 2000 volts, this so is indicated. If the ESD damage threshold below 2000 volts is measured for either polarity, numbers are indicated that represent worst case values observed in product characterization.

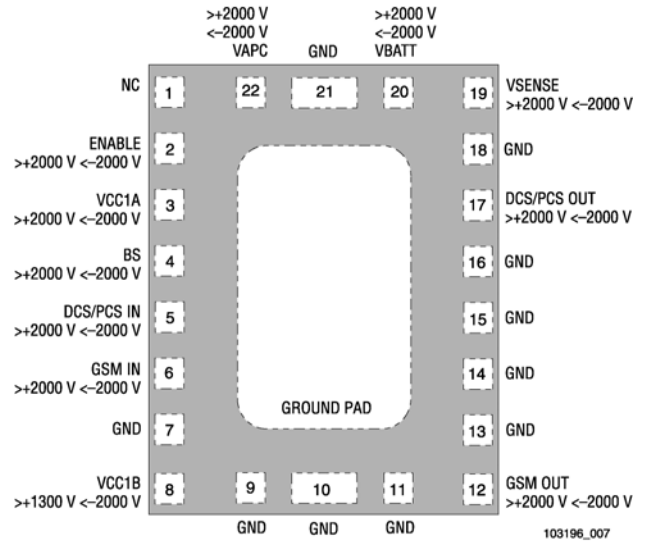


Figure 7. ESD Sensitivity Areas (Top View)

Various failure criteria can be utilized when performing ESD testing. Many vendors employ relaxed ESD failure standards, which fail devices only after “the pin fails the electrical specification limits” or “the pin becomes completely non-functional”. Skyworks’ most stringent criteria fail devices as soon as the pin begins to show any degradation on a curve tracer. To avoid ESD damage, both latent and visible, it is very important that the product assembly and test areas follow the Class-1 ESD handling precautions listed in [Table 5](#).

Table 5. Precautions for Handling GaAs IC based Products to Avoid ESD Induced Damage

Personnel Grounding	Facility
Wrist Straps Conductive Smocks, Gloves and Finger Cots Antistatic ID Badges	Relative Humidity Control and Air Ionizers Dissipative Floors (less than 10 ⁹ Ω to GND)
Protective Workstation	Protective Packaging & Transportation
Dissipative Table Tops Protective Test Equipment (Properly Grounded) Grounded Tip Soldering Irons Conductive Solder Suckers Static Sensors	Bags and Pouches (Faraday Shield) Protective Tote Boxes (Conductive Static Shielding) Protective Trays Grounded Carts Protective Work Order Holders

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Technical Information

Closed loop control of the amplifier is enabled when ENABLE is driven to logic high. The PA collector current will then be directly proportional to the V_{APC} input voltage over the range of 200 mV to 2.1 V.

To meet the GSM power versus time mask and switching transient requirements the PAM must be provided with a DAC ramp profile on the V_{APC} input as well as proper timing on digital controls for the PAC circuitry.

Note: *Please refer to 3GPP TS 51.010-1: Mobile Station (MS) conformance specification. All GSM specifications are now the responsibility of 3GPP. The standards are available at <http://www.3gpp.org>.*

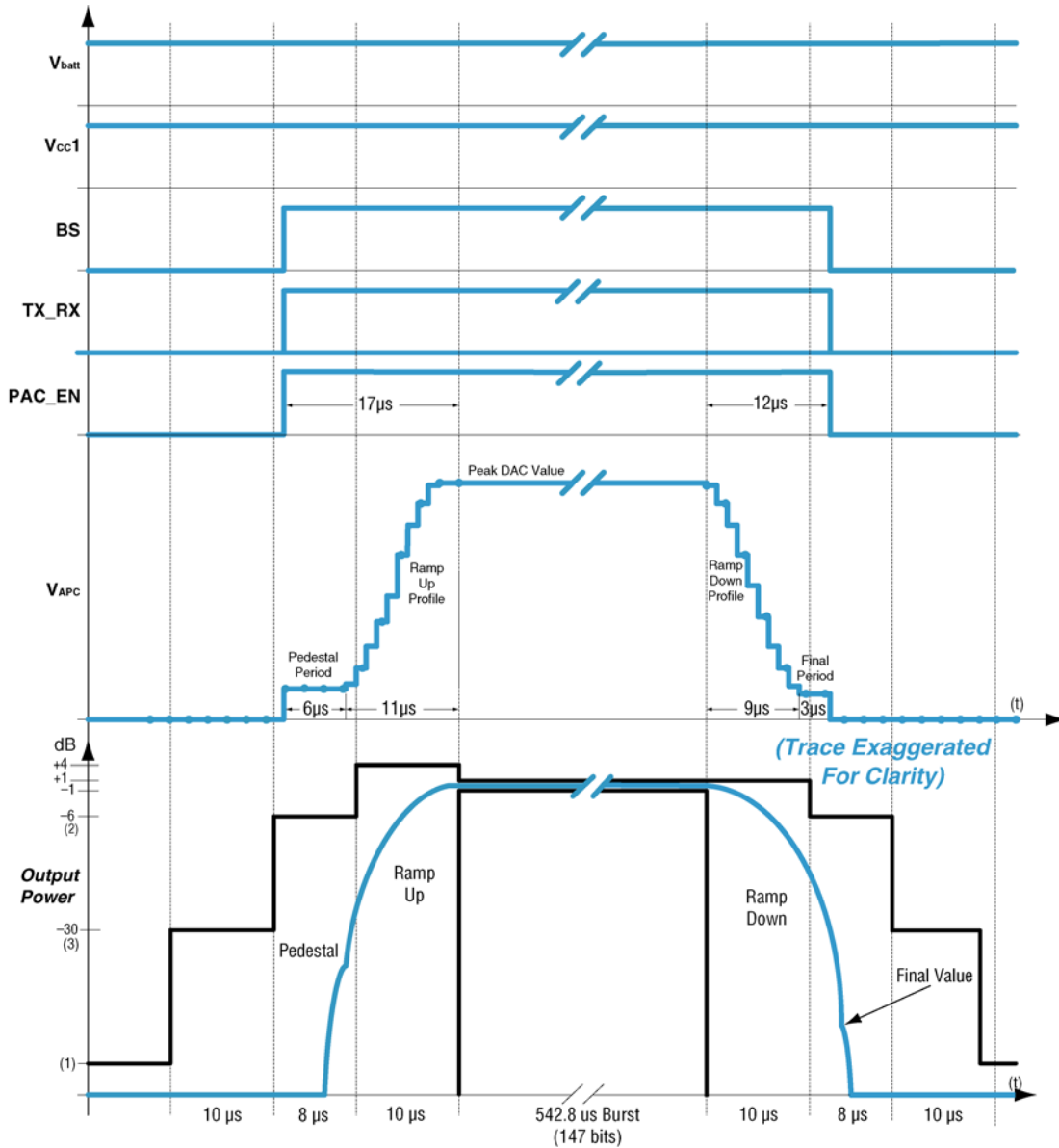
The SKY77325 has been designed to comply with interface requirements and DAC resolution of leading base band devices. The ramp profile typically consists of a pedestal voltage, 10–16 discrete voltage steps on the rising edge of the burst, a constant region, 10–16 steps on the falling edge, and a final voltage. Typically, the user defines the start, stop, and 10–16 percentage values for each rising and falling edge, which are then applied as discrete voltages at the V_{APC} input. For the SKY77325, generally the same profile, scaled in amplitude, is used for all frequencies and power control levels. The ultimate purpose is to keep the RF output power ramp within the time mask and to maintain

acceptable spectral limits at specified offset frequencies. The V_{APC} input has an internal reconstruction filter such that external resistors or capacitors are unnecessary on the phone board or the test fixture.

Figure 8 represents the dynamic characteristics of the RF output burst power that results from the ramp profile delivered by the DAC to the V_{APC} input. The transmit power must not exceed the given limits at the time specified relative to the start and end of the data burst. Additional requirements are placed on spectral components generated by switching transients. Ramping at high rates will result in components that violate these spectral limits. A ramp control signal must be applied to the V_{APC} pin, which results in the desired power ramp response. The log relationship of V_{APC} to P_{OUT} , along with the finite bandwidth and potential slew rate limitations of the feedback loop, results in a complex mapping of the ramp profile to the actual output power. Careful attention is required in generating the input waveform which results in the desired output response.

Figure 9 shows an example of the Skyworks PAM test setup for evaluation of RF performance with various ramp profiles. The user's test setup may also include a TX/RX switch and a diplexer in the output signal path. Alternatively, the SKY77325 PAM may be installed in a phone board.

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- (1) For GSM850 / EGSM -59 dBc or -36 dBm, whichever is higher.
For DCS1800 / PCS1900 -48 dBc or -48 dBm, whichever is higher.
- (2) For GSM850 / EGSM -4 dBc for power control level 16,
-2 dBc for power control level 17,
-1 dBc for power control level 18 and 19.
For DCS1800 / PCS1900 -4 dBc for power control level 11,
-2 dBc for power control level 12,
-1 dBc for power control level 13, 14, 15.
- (3) For GSM850 / EGSM -30 dBc or -17 dBm, whichever is higher.
For DCS1800 / PCS1900 -30 dBc or -20 dBm, whichever is higher.

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Figure 8. Example of PAM Recommended Timing Diagram

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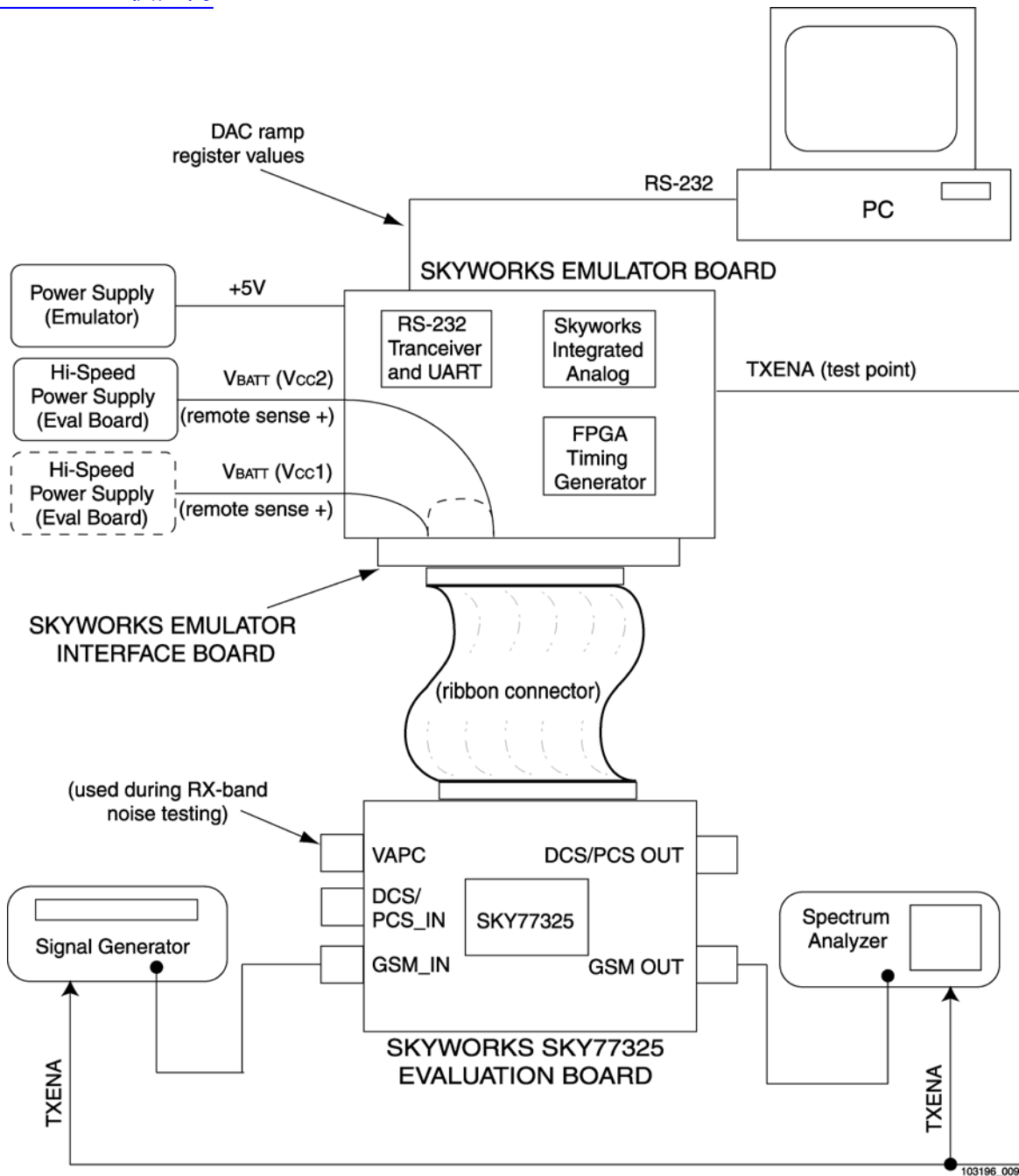


Figure 9. PAM Evaluation Test Setup.

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Ordering Information

Model Number	Manufacturing Part Number	Package	Operating Temperature
SKY77325	SKY77325	6 x 8 x 1.2 mm	-20 °C to +100 °C

Revision History

Revision	Level	Date	Description
P1		November 3, 2003	Preliminary Information
P2		November 26, 2003	Revise: Table 3
P3		January 6, 2004	Revise: Tables 3, 4; Figures 2, 5, 7 Delete: Pg 16, last two paragraphs; Figures 10, 11, 12
P4		January 21, 2004	Revise: Table 3
P5		May 14, 2004	Revise: Figure 8

References

Application Note: Tape and Reel, Document Number 101568

Application Note: PCB Design and SMT Assembly/Rework, Document Number 101752

Application Brief: iPAC™ GSM Transmitter Timing, Calibration and Baseband Control, Document Number 103138

Application Note: iPAC™ Peak Output Power Calibration, Document Number 103180

User Guide: iPAC™ Test and Control – Baseband Emulator Interface, Document Number 103125

JEDEC Standard J–STD–020B

3GPP TS 51.010-1; Mobile Station (MS) Conformance Specification (<http://www.3gpp.org>)

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